Dual supply translating transceiver; 3-state Rev. 01 — 11 May 2009

Product data sheet

1. **General description**

The 74LVC1T45; 74LVCH1T45 are single bit, dual supply transceivers with 3-state outputs that enables bidirectional level translation. They feature one data input-output port (A and B), a direction control input (DIR) and dual supply pins ($V_{CC(A)}$ and $V_{CC(B)}$). Both $V_{CC(A)}$ and $V_{CC(B)}$ can be supplied at any voltage between 1.2 V and 5.5 V making the device suitable for translating between any of the low voltage nodes (1.2 V, 1.5 V, 1.8 V, 2.5 V, 3.3 V and 5.0 V). Pins A and DIR are referenced to V_{CC(A)} and pin B is referenced to V_{CC(B)}. A HIGH on DIR allows transmission from A to B and a LOW on DIR allows transmission from B to A.

The devices are fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either $V_{CC(A)}$ or $V_{CC(B)}$ are at GND level, both A port and B port are in the high-impedance OFF-state.

Active bus hold circuitry in the 74LVCH1T45 holds unused or floating data inputs at a valid logic level.

2. Features

- Wide supply voltage range:
 - V_{CC(A)}: 1.2 V to 5.5 V
 - V_{CC(B)}: 1.2 V to 5.5 V
- High noise immunity
- Complies with JEDEC standards:
 - JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
 - JESD36 (4.5 V to 5.5 V)
- ESD protection:
 - HBM JESD22-A114E Class 3A exceeds 4000 V
 - CDM JESD22-C101C exceeds 1000 V
- Maximum data rates:
 - 420 Mbps (3.3 V to 5.0 V translation)
 - 210 Mbps (translate to 3.3 V))
 - 140 Mbps (translate to 2.5 V)
 - 75 Mbps (translate to 1.8 V)
 - 60 Mbps (translate to 1.5 V)
- Suspend mode



Dual supply translating transceiver; 3-state

- Latch-up performance exceeds 100 mA per JESD 78 Class II
- ± 24 mA output drive (V_{CC} = 3.0 V)
- Inputs accept voltages up to 5.5 V
- Low power consumption: 16 μA maximum I_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

Table 1.	Ordering information
----------	----------------------

Type number	Package							
	Temperature range	Name	Description	Version				
74LVC1T45GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363				
74LVCH1T45GW								
74LVC1T45GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads;	SOT886				
74LVCH1T45GM			6 terminals; body $1 \times 1.45 \times 0.5$ mm					
74LVC1T45GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads;	SOT891				
74LVCH1T45GF			6 terminals; body $1 \times 1 \times 0.5$ mm					

4. Marking

Table 2.Marking

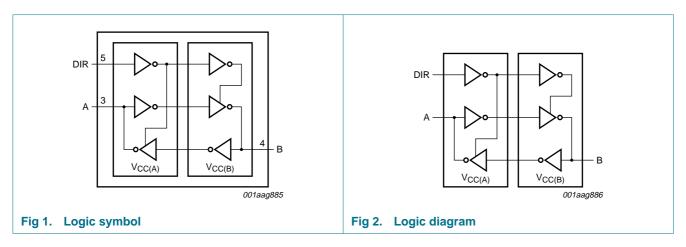
Type number	Marking code ^[1]
74LVC1T45GW	V5
74LVCH1T45GW	X5
74LVC1T45GM	V5
74LVCH1T45GM	X5
74LVC1T45GF	V5
74LVCH1T45GF	X5

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.



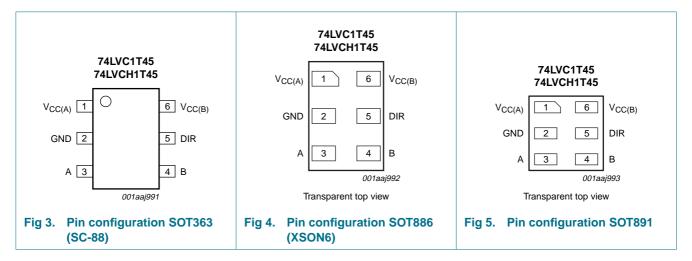
Dual supply translating transceiver; 3-state

5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

. ..

Table 3.	Pin description	
Symbol	Pin	Description
V _{CC(A)}	1	supply voltage port A and DIR
GND	2	ground (0 V)
А	3	data input or output
В	4	data input or output
DIR	5	direction control
V _{CC(B)}	6	supply voltage port B

74LVC_LVCH1T45_1
Product data sheet

. .

Dual supply translating transceiver; 3-state

7. Functional description

Table 4. Function table	le ^[1]			
Supply voltage Input Input/output ^[2]				
V _{CC(A)} , V _{CC(B)}	DIR	A	В	
1.2 V to 5.5 V	L	A = B	input	
1.2 V to 5.5 V	Н	input	B = A	
GND ^[3]	Х	Z	Z	

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

[2] The input circuit of the data I/O is always active.

[3] When either V_{CC(A)} or V_{CC(B)} is at GND level, the device goes into suspend mode.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		-0.5	+6.5	V
V _{CC(B)}	supply voltage B		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode	<u>[1][2][3]</u> –0.5	$V_{CCO} + 0.5$	V
		Suspend or 3-state mode	<u>[1]</u> –0.5	+6.5	V
l _O	output current	$V_{O} = 0 V$ to V_{CCO}	[2] _	±50	mA
I _{CC}	supply current	$I_{CC(A)}$ or $I_{CC(B)}$	-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	<u>[4]</u> _	250	mW

[1] The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] V_{CCO} is the supply voltage associated with the output port.

[3] V_{CCO} + 0.5 V should not exceed 6.5 V.

[4] For SC-88 package: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 package: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		1.2	5.5	V
V _{CC(B)}	supply voltage B		1.2	5.5	V
VI	input voltage		0	5.5	V

74LVC1T45; 74LVCH1T45

Dual supply translating transceiver; 3-state

Table 6.	Recommended operating condit	clonscontinued			
Symbol	Parameter	Conditions	Min	Max	Unit
Vo	output voltage	Active mode	<u>[1]</u> 0	V _{CCO}	V
		Suspend or 3-state mode	0	5.5	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CCI} = 1.2 V to 5.5 V	[2] _	5	ns/V

Table 6 **Becommended exercting conditions**

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the input port.

10. Static characteristics

Table 7. Typical static characteristics at T_{amb} = 25 °C

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$	<u>[1]</u>				
		$I_{O} = -3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$		-	1.09	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$					
		$I_0 = 3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$	[1]	-	0.07	-	V
l _l	input leakage current	DIR input; $V_1 = 0 V$ to 5.5 V; $V_{CCI} = 1.2 V$ to 5.5 V	[2]	-	-	±1	μA
I _{BHL}	bus hold LOW current	A or B port; $V_I = 0.42$ V; $V_{CCI} = 1.2$ V	[2]	-	19	-	μΑ
I _{BHH}	bus hold HIGH current	A or B port; $V_I = 0.78$ V; $V_{CCI} = 1.2$ V	[2]	-	-19	-	μΑ
I _{BHLO}	bus hold LOW overdrive current	A or B port; V_{CCI} = 1.2 V	[2][3]	-	19	-	μA
I _{BHHO}	bus hold HIGH overdrive current	A or B port; $V_{CCI} = 1.2 V$	[2][3]	-	-19	-	μA
I _{OZ}	OFF-state output current	A or B port; $V_0 = 0$ V or V_{CCO} ; $V_{CCO} = 1.2$ V to 5.5 V	<u>[1]</u>	-	-	±1	μA
I _{OFF}	power-off leakage current	A port; V _I or V _O = 0 V to 5.5 V; V _{CC(A)} = 0 V; V _{CC(B)} = 1.2 V to 5.5 V		-	-	±1	μA
		B port; V _I or V _O = 0 V to 5.5 V; V _{CC(B)} = 0 V; V _{CC(A)} = 1.2 V to 5.5 V		-	-	±1	μA
CI	input capacitance	DIR input; $V_1 = 0 V \text{ or } 5.5 V$; $V_{CC(A)} = V_{CC(B)} = 5.5 V$		-	2.2	-	pF
C _{I/O}	input/output capacitance	A and B port; suspend mode; $V_O = 3.3 \text{ V or } 0 \text{ V}; V_{CC(A)} = V_{CC(B)} = 3.3 \text{ V}$		-	6.0	-	pF

[1] V_{CCO} is the supply voltage associated with the output port.

V_{CCI} is the supply voltage associated with the data input port. [2]

[3] To guarantee the node switches, an external driver must source/sink at least I_{BHLO} / I_{BHHO} when the input is in the range V_{IL} to V_{IH}.

74LVC1T45; 74LVCH1T45

Dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions		−40 °C t	o +85 °C	_40 °C to	• +125 °C	Uni
				Min	Max	Min	Max	
VIH	HIGH-level	data input	[2]					
	input voltage	V _{CCI} = 1.2 V		0.8V _{CCI}	-	0.8V _{CCI}	-	V
		V _{CCI} = 1.4 V to 1.95 V		0.65V _{CCI}	-	0.65V _{CCI}	-	V
		V_{CCI} = 2.3 V to 2.7 V		1.7	-	1.7	-	V
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	-	2.0	-	V
		V_{CCI} = 4.5 V to 5.5 V		0.7V _{CCI}	-	0.7V _{CCI}	-	V
		DIR input						
		V _{CCI} = 1.2 V		0.8V _{CC(A)}	-	0.8V _{CC(A)}	-	V
		V _{CCI} = 1.4 V to 1.95 V	(0.65V _{CC(A)}	-	0.65V _{CC(A)}	-	V
		$V_{CCI} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		1.7	-	1.7	-	V
		$V_{CCI} = 3.0 V \text{ to } 3.6 V$		2.0	-	2.0	-	V
		$V_{CCI} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$		0.7V _{CC(A)}	-	0.7V _{CC(A)}	-	V
/ _{IL}	LOW-level input voltage	data input	[2]					
		V _{CCI} = 1.2 V		-	0.2V _{CCI}	-	0.2V _{CCI}	V
		$V_{CCI} = 1.4 \text{ V} \text{ to } 1.95 \text{ V}$		-	0.35V _{CCI}	-	0.35V _{CCI}	V
		$V_{CCI} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		-	0.7	-	0.7	V
		$V_{CCI} = 3.0 V \text{ to } 3.6 V$		-	0.8	-	0.8	V
		$V_{CCI} = 4.5 \text{ V}$ to 5.5 V		-	0.3V _{CCI}	-	0.3V _{CCI}	V
		DIR input						
		V _{CCI} = 1.2 V		-	0.2V _{CC(A)}	-	0.2V _{CC(A)}	V
		V _{CCI} = 1.4 V to 1.95 V		-	0.35V _{CC(A)}	-	0.35V _{CC(A)}	V
		$V_{CCI} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		-	0.7	-	0.7	V
		$V_{CCI} = 3.0 V \text{ to } 3.6 V$		-	0.8	-	0.8	V
		$V_{CCI} = 4.5 \text{ V}$ to 5.5 V		-	0.3V _{CC(A)}	-	0.3V _{CC(A)}	V
V _{он}	HIGH-level	$V_{I} = V_{IH}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CCO} = 1.2 \ V \text{ to } 4.5 \ V$	<u>[1]</u> N	V _{CCO} – 0.1	-	$V_{\rm CCO}-0.1$	-	V
		$I_{O} = -6 \text{ mA}; V_{CCO} = 1.4 \text{ V}$		1.0	-	1.0	-	V
		$I_{O} = -8 \text{ mA}; V_{CCO} = 1.65 \text{ V}$		1.2	-	1.2	-	V
		$I_{O} = -12 \text{ mA}; V_{CCO} = 2.3 \text{ V}$		1.9	-	1.9	-	V
		$I_{O} = -24 \text{ mA}; V_{CCO} = 3.0 \text{ V}$		2.4	-	2.4	-	V
		$I_{O} = -32 \text{ mA}; V_{CCO} = 4.5 \text{ V}$		3.8	-	3.8	-	V

Table 8. **Static characteristics**

74LVC1T45; 74LVCH1T45

Dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions		-40 °C to	o +85 °C	–40 °C to	+125 °C	Un
				Min	Max	Min	Max	
/ _{OL}	LOW-level	$V_{I} = V_{IL}$	<u>[1]</u>					
	output voltage	I _O = 100 μA; V _{CCO} = 1.2 V to 4.5 V		-	0.1	-	0.1	V
		$I_0 = 6 \text{ mA}; V_{CCO} = 1.4 \text{ V}$		-	0.3	-	0.3	V
		$I_0 = 8 \text{ mA}; V_{CCO} = 1.65 \text{ V}$		-	0.45	-	0.45	V
		$I_0 = 12 \text{ mA}; V_{CCO} = 2.3 \text{ V}$		-	0.3	-	0.3	V
		$I_{O} = 24 \text{ mA}; V_{CCO} = 3.0 \text{ V}$		-	0.55	-	0.55	V
		$I_{O} = 32 \text{ mA}; V_{CCO} = 4.5 \text{ V}$		-	0.55	-	0.55	V
I	input leakage current	DIR input; $V_1 = 0 V$ to 5.5 V; $V_{CCI} = 1.2 V$ to 5.5 V		-	±2	-	±10	μA
I _{BHL} bus hold LC current	bus hold LOW	A or B port	[2]					
	current	$V_{I} = 0.49 \text{ V}; V_{CCI} = 1.4 \text{ V}$		15	-	10	-	μA
		$V_{I} = 0.58 \text{ V}; V_{CCI} = 1.65 \text{ V}$		25	-	20	-	μΑ
		$V_{I} = 0.70 \text{ V}; V_{CCI} = 2.3 \text{ V}$		45	-	45	-	μA
		$V_{I} = 0.80 \text{ V}; V_{CCI} = 3.0 \text{ V}$		100	-	80	-	μA
		$V_{I} = 1.35 \text{ V}; V_{CCI} = 4.5 \text{ V}$		100	-	100	-	μA
внн	bus hold HIGH	A or B port	[2]					
	current	$V_{I} = 0.91 \text{ V}; V_{CCI} = 1.4 \text{ V}$		-15	-	-10	-	μA
		$V_{I} = 1.07 \text{ V}; V_{CCI} = 1.65 \text{ V}$		-25	-	-20	-	μA
		$V_{I} = 1.60 \text{ V}; V_{CCI} = 2.3 \text{ V}$		-45	-	-45	-	μA
		$V_{I} = 2.00 \text{ V}; V_{CCI} = 3.0 \text{ V}$		-100	-	-80	-	μA
		$V_{I} = 3.15 \text{ V}; V_{CCI} = 4.5 \text{ V}$		-100	-	-100	-	μA
BHLO	bus hold LOW	A or B port	[2][3]					
	overdrive current	V _{CCI} = 1.6 V		125	-	125	-	μA
	current	V _{CCI} = 1.95 V		200	-	200	-	μA
		$V_{CCI} = 2.7 V$		300	-	300	-	μA
		V _{CCI} = 3.6 V		500	-	500	-	μA
		V _{CCI} = 5.5 V		900	-	900	-	μA
внно	bus hold HIGH	A or B port	[2][3]					
	overdrive current	V _{CCI} = 1.6 V		-125	-	-125	-	μA
	Guirein	V _{CCI} = 1.95 V		-200	-	-200	-	μA
		V _{CCI} = 2.7 V		-300	-	-300	-	μA
		V _{CCI} = 3.6 V		-500	-	-500	-	μA
		V _{CCI} = 5.5 V		-900	-	-900	-	μA
OZ	OFF-state output current	A or B port; $V_0 = 0$ V or V_{CCO} ; $V_{CCO} = 1.2$ V to 5.5 V	<u>[1]</u>	-	±2	-	±10	μA

Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions		–40 °C t	o +85 °C	–40 °C to	o +125 °C	Unit
				Min	Max	Min	Max	
I _{OFF}	power-off leakage current	A port; V _I or V _O = 0 V to 5.5 V; V _{CC(A)} = 0 V; V _{CC(B)} = 1.2 V to 5.5 V		-	±2 - ±10	μΑ		
		B port; V ₁ or V _O = 0 V to 5.5 V; V _{CC(B)} = 0 V; V _{CC(A)} = 1.2 V to 5.5 V		-	±2	-	±10	μA
I _{CC}	supply current	A port; $V_I = 0$ V or V_{CCI} ; $I_O = 0$ A	[2]					
		$V_{CC(A)}$, $V_{CC(B)} = 1.2$ V to 5.5 V		-	8	-	8	μA
		$V_{CC(A)}$, $V_{CC(B)} = 1.65$ V to 5.5 V		-	3	-	3	μΑ
		$V_{CC(A)} = 5.5 \text{ V}; V_{CC(B)} = 0 \text{ V}$		-	2	-	2	μA
		$V_{CC(A)} = 0 \text{ V}; V_{CC(B)} = 5.5 \text{ V}$		-2	-	-2	-	μA
		B port; $V_I = 0$ V or V_{CCI} ; $I_O = 0$ A						
		$V_{CC(A)}$, $V_{CC(B)} = 1.2$ V to 5.5 V		-	8	-	8	μΑ
		$V_{CC(A)}$, $V_{CC(B)} = 1.65$ V to 5.5 V		-	3	-	3	μA
		$V_{CC(B)} = 5.5 \text{ V}; V_{CC(A)} = 0 \text{ V}$		-	2	-	2	μA
		$V_{CC(B)} = 0 V; V_{CC(A)} = 5.5 V$		-2	-	-2	-	μA
		A plus B port ($I_{CC(A)} + I_{CC(B)}$); $I_O = 0$ A; $V_I = 0$ V or V_{CCI}						
		$V_{CC(A)}$, $V_{CC(B)} = 1.2$ V to 5.5 V		-	16	-	16	μA
		$V_{CC(A)}$, $V_{CC(B)} = 1.65$ V to 5.5 V		-	4	-	4	μA
ΔI_{CC}	additional	$V_{CC(A)},V_{CC(B)}$ = 3.0 V to 5.5 V						
	supply current	A port; A port at $V_{CC(A)} - 0.6$ V; DIR at $V_{CC(A)}$; B port = open	<u>[4]</u>	-	50	-	75	μA
		DIR input; DIR at $V_{CC(A)} - 0.6 V$; A port at $V_{CC(A)}$ or GND; B port = open		-	50	-	75	μΑ
		B port; B port at $V_{CC(B)} - 0.6 V$; DIR at GND; A port = open	<u>[4]</u>	-	50	-	75	μΑ

Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the data input port.

[3] To guarantee the node switches, an external driver must source/sink at least I_{BHLO} / I_{BHHO} when the input is in the range V_{IL} to V_{IH}.

[4] For non bus hold parts only (74LVC1T45).

Dual supply translating transceiver; 3-state

11. Dynamic characteristics

Table 9.Typical dynamic characteristics at $V_{CC(A)} = 1.2$ V and $T_{amb} = 25$ °CVoltages are referenced to GND (ground = 0 V); for test circuit see Figure 8; for waveforms see Figure 6 and Figure 7

Symbol	Parameter	Conditions			Vco	С(В)			Unit
			1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t _{PLH}	LOW to HIGH	A to B	10.6	8.1	7.0	5.8	5.3	5.1	ns
	propagation delay	B to A	10.6	9.5	9.0	8.5	8.3	8.2	ns
t _{PHL}	HIGH to LOW	A to B	10.1	7.1	6.0	5.3	5.2	5.4	ns
	propagation delay	B to A	10.1	8.6	8.1	7.8	7.6	7.6	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	9.4	9.4	9.4	9.4	9.4	9.4	ns
	propagation delay	DIR to B	12.0	9.4	9.0	7.8	8.4	7.9	ns
t _{PLZ}	LOW to OFF-state	DIR to A	7.1	7.1	7.1	7.1	7.1	7.1	ns
	propagation delay	DIR to B	9.5	7.8	7.7	6.9	7.6	7.0	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	20.1	17.3	16.7	15.4	15.9	15.2	ns
	propagation delay	DIR to B [1]	17.7	15.2	14.1	12.9	12.4	12.2	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	22.1	18.0	17.1	15.6	16.0	15.5	ns
propagation delay	DIR to B [1]	19.5	16.5	15.4	14.7	14.6	14.8	ns	

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times"

Table 10. Typical dynamic characteristics at $V_{CC(B)}$ = 1.2 V and T_{amb} = 25 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8; for waveforms see Figure 6 and Figure 7

-				<u> </u>					_
Symbol	Parameter	Conditions			Vc	C(A)			Unit
			1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t _{PLH}	LOW to HIGH	A to B	10.6	9.5	9.0	8.5	8.3	8.2	ns
	propagation delay	B to A	10.6	8.1	7.0	5.8	5.3	5.1	ns
t _{PHL}	HIGH to LOW	A to B	10.1	8.6	8.1	7.8	7.6	7.6	ns
	propagation delay	B to A	10.1	7.1	6.0	5.3	5.2	5.4	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	9.4	6.5	5.7	4.1	4.1	3.0	ns
	propagation delay	DIR to B	12.0	6.1	5.4	4.6	4.3	4.0	ns
t _{PLZ}	LOW to OFF-state	DIR to A	7.1	4.9	4.5	3.2	3.4	2.5	ns
	propagation delay	DIR to B	9.5	7.3	6.6	5.9	5.7	5.6	ns
t _{PZH}	OFF-state to HIGH	DIR to A	20.1	15.4	13.6	11.7	11.0	10.7	ns
	propagation delay	DIR to B	17.7	14.4	13.5	11.7	11.7	10.7	ns
t _{PZL} OFF-state to LOW propagation delay	DIR to A	22.1	13.2	11.4	9.9	9.5	9.4	ns	
	propagation delay	DIR to B	19.5	15.1	13.8	11.9	11.7	10.6	ns

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times"

Dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions		V _{CC(A)} ai	nd V _{CC(B)}		Unit
			1.8 V	2.5 V	3.3 V	5.5 V	
C _{PD}	power dissipation capacitance	A port: (direction A to B); B port: (direction B to A)	2	3	3	4	pF
		A port: (direction B to A); B port: (direction A to B)	15	16	16	18	pF

Table 11. Typical power dissipation capacitance at $V_{CC(A)} = V_{CC(B)}$ and $T_{amb} = 25 \text{ °C}$ [1][2] *Voltages are referenced to GND (around = 0 V).*

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

fo = output frequency in MHz;

 C_L = load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

Table 12. Dynamic characteristics for temperature range -40 °C to +85 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8; for wave forms see Figure 6 and Figure 7

Symbol	Parameter	Conditions					Vcc	;(B)					Unit
			1.5 V ±	± 0.1 V	1.8 V ±	0.15 V	2.5 V :	± 0.2 V	3.3 V -	± 0.3 V	5.0 V -	± 0.5 V	-
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
V _{CC(A)} =	1.4 V to 1.6 V												
t _{PLH}	LOW to HIGH	A to B	2.8	21.3	2.4	17.6	2.0	13.5	1.7	11.8	1.6	10.5	ns
	propagation delay	B to A	2.8	21.3	2.6	19.1	2.3	14.9	2.3	12.4	2.2	12.0	ns
t _{PHL}	HIGH to LOW	A to B	2.6	19.3	2.2	15.3	1.8	11.8	1.7	10.9	1.7	10.8	ns
	propagation delay	B to A	2.6	19.3	2.4	17.3	2.3	13.2	2.2	11.3	2.3	11.0	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	3.0	18.7	3.0	18.7	3.0	18.7	3.0	18.7	3.0	18.7	ns
	propagation delay	DIR to B	3.5	24.8	3.5	23.6	3.0	11.0	3.3	11.3	2.8	10.3	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.4	11.4	2.4	11.4	2.4	11.4	2.4	11.4	2.4	11.4	ns
	propagation delay	DIR to B	2.8	18.3	3.0	17.2	2.5	9.4	3.0	10.1	2.5	9.4	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	39.6	-	36.3	-	24.3	-	22.5	-	21.4	ns
	propagation delay	DIR to B [1]	-	32.7	-	29.0	-	24.9	-	23.2	-	21.9	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	-	44.1	-	40.9	-	24.2	-	22.6	-	21.3	ns
	propagation delay	DIR to B [1]	-	38.0	-	34.0	-	30.5	-	29.6	-	29.5	ns
$V_{CC(A)} =$	1.65 V to 1.95 V												
t _{PLH}	LOW to HIGH	A to B	2.6	19.1	2.2	17.7	2.2	9.3	1.7	7.2	1.4	6.8	ns
	propagation delay	B to A	2.4	17.6	2.2	17.7	2.3	16.0	2.1	15.5	1.9	15.1	ns
t _{PHL}	HIGH to LOW	A to B	2.4	17.3	2.0	14.3	1.6	8.5	1.8	7.1	1.7	7.0	ns
	propagation delay	B to A	2.2	15.3	2.0	14.3	2.1	12.9	2.0	12.6	1.8	12.2	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	2.9	17.1	2.9	17.1	2.9	17.1	2.9	17.1	2.9	17.1	ns
	propagation delay	DIR to B	3.2	24.1	3.2	21.9	2.7	11.5	3.0	10.3	2.5	8.2	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.4	10.5	2.4	10.5	2.4	10.5	2.4	10.5	2.4	10.5	ns
	propagation dalay	DIR to B	2.5	17.6	2.6	16.0	2.2	9.2	2.7	8.4	2.4	6.4	ns

74LVC_LVCH1T45_1

10 of 30

Symbol	Parameter	Conditions					٧ _{co}	C(B)					Uni
			1.5 V	± 0.1 V	1.8 V ±	0.15 V		± 0.2 V	3.3 V :	± 0.3 V	5.0 V	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
PZH	OFF-state to HIGH	DIR to A [1]	-	35.2	-	33.7	-	25.2	-	23.9	-	21.8	ns
	propagation delay	DIR to B [1]	-	29.6	-	28.2	-	19.8	-	17.7	-	17.3	ns
PZL	OFF-state to LOW	DIR to A [1]	-	39.4	-	36.2	-	24.4	-	22.9	-	20.4	ns
	propagation delay	DIR to B [1]	-	34.4	-	31.4	-	25.6	-	24.2	-	24.1	ns
/ _{CC(A)} =	2.3 V to 2.7 V												
PLH	LOW to HIGH	A to B	2.3	17.9	2.3	16.0	1.5	8.5	1.3	6.2	1.1	4.8	ns
	propagation delay	B to A	2.0	13.5	2.2	9.3	1.5	8.5	1.4	8.0	1.0	7.5	ns
PHL	HIGH to LOW	A to B	2.3	15.8	2.1	12.9	1.4	7.5	1.3	5.4	0.9	4.6	ns
	propagation delay	B to A	1.8	11.8	1.9	8.5	1.4	7.5	1.3	7.0	0.9	6.2	ns
PHZ	HIGH to OFF-state	DIR to A	2.1	8.1	2.1	8.1	2.1	8.1	2.1	8.1	2.1	8.1	ns
	propagation delay	DIR to B	3.0	22.5	3.0	21.4	2.5	11.0	2.8	9.3	2.3	6.9	ns
PLZ	LOW to OFF-state	DIR to A	1.7	5.8	1.7	5.8	1.7	5.8	1.7	5.8	1.7	5.8	ns
	propagation delay	DIR to B	2.3	14.6	2.5	13.2	2.0	9.0	2.5	8.4	1.8	5.3	ns
PZH	OFF-state to HIGH	DIR to A [1]	-	28.1	-	22.5	-	17.5	-	16.4	-	12.8	ns
	propagation delay	DIR to B [1]	-	23.7	-	21.8	-	14.3	-	12.0	-	10.6	ns
PZL	OFF-state to LOW	DIR to A [1]	-	34.3	-	29.9	-	18.5	-	16.3	-	13.1	ns
	propagation delay	DIR to B [1]	-	23.9	-	21.0	-	15.6	-	13.5	-	12.7	ns
/ _{CC(A)} =	3.0 V to 3.6 V												
PLH	LOW to HIGH	A to B	2.3	17.1	2.1	15.5	1.4	8.0	0.8	5.6	0.7	4.4	ns
	propagation delay	B to A	1.7	11.8	1.7	7.2	1.3	6.2	0.7	5.6	0.6	5.4	ns
PHL	HIGH to LOW	A to B	2.2	15.6	2.0	12.6	1.3	7.0	0.8	5.0	0.7	4.0	ns
	propagation delay	B to A	1.7	10.9	1.8	7.1	1.3	5.4	0.8	5.0	0.7	4.5	ns
PHZ	HIGH to OFF-state	DIR to A	2.3	7.3	2.3	7.3	2.3	7.3	2.3	7.3	2.7	7.3	ns
	propagation delay	DIR to B	2.9	18.0	2.9	16.5	2.3	10.1	2.7	8.6	2.2	6.3	ns
PLZ	LOW to OFF-state	DIR to A	2.0	5.6	2.0	5.6	2.0	5.6	2.0	5.6	2.0	5.6	ns
	propagation delay	DIR to B	2.3	13.6	2.4	12.5	1.9	7.8	2.3	7.1	1.7	4.9	ns
PZH	OFF-state to HIGH	DIR to A [1]	-	25.4	-	19.7	-	14.0	-	12.7	-	10.3	ns
	propagation delay	DIR to B [1]	-	22.7	-	21.1	-	13.6	-	11.2	-	10.0	ns
PZL	OFF-state to LOW	DIR to A [1]	-	28.9	-	23.6	-	15.5	-	13.6	-	10.8	ns
	propagation delay	DIR to B [1]	-	22.9	-	19.9	-	14.3	-	12.3	-	11.3	ns
/ _{CC(A)} =	4.5 V to 5.5 V												
PLH	LOW to HIGH	A to B	2.2	16.6	1.9	15.1	1.0	7.5	0.7	5.4	0.5	3.9	ns
	propagation delay	B to A	1.6	10.5	1.4	6.8	1.0	4.8	0.7	4.4	0.5	3.9	ns
PHL	HIGH to LOW	A to B	2.3	15.3	1.8	12.2	1.0	6.2	0.7	4.5	0.5	3.5	ns
	propagation delay	B to A	1.7	10.8	1.7	7.0	0.9	4.6	0.7	4.0	0.5	3.5	ns
PHZ	HIGH to OFF-state	DIR to A	1.7	5.4	1.7	5.4	1.7	5.4	1.7	5.4	1.7	5.4	ns
• -=	propagation delay	DIR to B	2.9	17.3	2.9	16.1	2.3	9.7	2.7	8.0	2.5	5.7	ns

Table 12. Dynamic characteristics for temperature range $-40 \degree C$ to $+85 \degree C$...continued Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8; for wave forms see Figure 6 and Figure

Dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions					Vcc	(B)					Unit			
			1.5 V	0.1 V	1.8 V ±	0.15 V	2.5 V ±	0.2 V	3.3 V ±	± 0.3 V	5.0 V ±	0.5 V				
			Min	Max	Min	Мах	Min	Max	Min	Max	Min	Max				
t _{PLZ}	LOW to OFF-state	DIR to A	1.4	3.7	1.4	3.7	1.3	3.7	1.0	3.7	0.9	3.7	ns			
	propagation delay	propagation delay	propagation delay	propagation delay	DIR to B	2.3	13.1	2.4	12.1	1.9	7.4	2.3	7.0	1.8	4.5	ns
t _{PZH}		DIR to A [1]	-	23.6	-	18.9	-	12.2	-	11.4	-	8.4	ns			
	propagation delay	DIR to B [1]	-	20.3	-	18.8	-	11.2	-	9.1	-	7.6	ns			
t _{PZL}	PZL propagation daloy	DIR to A [1]	-	28.1	-	23.1	-	14.3	-	12.0	-	9.2	ns			
		DIR to B [1]	-	20.7	-	17.6	-	11.6	-	9.9	-	8.9	ns			

Table 12. Dynamic characteristics for temperature range $-40 \degree$ C to $+85 \degree$ C ... continued Voltages are referenced to GND (ground = 0 V): for test circuit see Figure 8: for wave forms see Figure 6 and Figure 7.

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times"

Table 13. Dynamic characteristics for temperature range –40 °C to +125 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8; for wave forms see Figure 6 and Figure 7

Symbol	Parameter	Conditions					Vcc	;(B)					Unit
			1.5 V :	± 0.1 V	1.8 V ±	0.15 V	2.5 V :	± 0.2 V	3.3 V -	± 0.3 V	5.0 V =	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	1
$V_{CC(A)} =$	1.4 V to 1.6 V												
t _{PLH}	LOW to HIGH	A to B	2.5	23.5	2.1	19.4	1.8	14.9	1.5	13.0	1.4	11.6	ns
	propagation delay	B to A	2.5	23.5	2.3	21.1	2.0	16.4	2.0	13.7	1.9	13.2	ns
t _{PHL}	HIGH to LOW	A to B	2.3	21.3	1.9	16.9	1.6	13.0	1.5	12.0	1.5	11.9	ns
	propagation delay	B to A	2.3	21.3	2.1	19.1	2.0	14.6	1.9	12.5	2.0	12.1	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	2.7	20.6	2.7	20.6	2.7	20.6	2.7	20.6	2.7	20.6	ns
	propagation delay	DIR to B	3.1	27.3	3.1	26.0	2.7	12.1	2.9	12.5	2.5	11.4	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.1	12.6	2.1	12.6	2.1	12.6	2.1	12.6	2.1	12.6	ns
	propagation delay	DIR to B	2.5	20.2	2.7	19.0	2.2	10.4	2.7	11.2	2.2	10.4	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	43.7	-	40.1	-	26.8	-	24.9	-	23.6	ns
	propagation delay	DIR to B [1]	-	36.1	-	32.0	-	27.5	-	25.6	-	24.2	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	-	48.6	-	45.1	-	26.7	-	25.0	-	23.5	ns
	propagation delay	DIR to B [1]	-	41.9	-	37.5	-	33.6	-	32.6	-	32.5	ns
$V_{CC(A)} =$	1.65 V to 1.95 V												
t _{PLH}	LOW to HIGH	A to B	2.3	21.1	1.9	19.5	1.9	10.3	1.5	8.0	1.2	7.5	ns
	propagation delay	B to A	2.1	19.4	1.9	19.5	2.0	17.6	1.8	17.1	1.7	16.7	ns
t _{PHL}	HIGH to LOW	A to B	2.1	19.1	1.8	15.8	1.4	9.4	1.6	7.9	1.5	7.7	ns
	propagation delay	B to A	1.9	16.9	1.8	15.8	1.8	14.2	1.8	13.9	1.6	13.5	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	2.6	18.9	2.6	18.9	2.6	18.9	2.6	18.9	2.6	18.9	ns
	propagation delay	DIR to B	2.8	26.6	2.8	24.1	2.4	12.7	2.7	11.4	2.2	9.1	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.1	11.6	2.1	11.6	2.1	11.6	2.1	11.6	2.1	11.6	ns
	memoration dalars	DIR to B	2.2	19.4	2.3	17.6	1.9	10.2	2.4	9.3	2.1	7.4	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	38.8	-	37.1	-	27.8	-	26.4	-	24.1	ns
	propagation dalay	DIR to B [1]	-	32.7	-	31.1	-	21.9	-	19.6	-	19.1	ns

Dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions					Vcc	;(B)					Uni
			1.5 V	± 0.1 V	1.8 V ±	0.15 V			3.3 V -	± 0.3 V	5.0 V ±	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
PZL	OFF-state to LOW	DIR to A [1]	-	43.5	-	39.9	-	26.9	-	25.3	-	22.6	ns
	propagation delay	DIR to B [1]	-	38.0	-	34.7	-	28.3	-	26.8	-	26.6	ns
V _{CC(A)} =	2.3 V to 2.7 V												
t _{PLH}	LOW to HIGH	A to B	2.0	19.7	2.0	17.6	1.3	9.4	1.1	6.9	0.9	5.3	ns
	propagation delay	B to A	1.8	14.9	1.9	10.3	1.3	9.4	1.2	8.8	0.9	8.3	ns
t _{PHL}	HIGH to LOW	A to B	2.0	17.4	1.8	14.2	1.2	8.3	1.1	6.0	0.8	5.1	ns
	propagation delay	B to A	1.6	13.0	1.7	9.4	1.2	8.3	1.1	7.7	0.8	6.9	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	1.8	9.0	1.8	9.0	1.8	9.0	1.8	9.0	1.8	9.0	ns
	propagation delay	DIR to B	2.7	24.8	2.7	23.6	2.2	12.1	2.5	10.3	2.0	7.6	ns
t _{PLZ}	LOW to OFF-state	DIR to A	1.5	6.4	1.5	6.4	1.5	6.4	1.5	6.4	1.5	6.4	ns
	propagation delay	DIR to B	2.0	16.1	2.2	14.6	1.8	9.9	2.2	9.3	1.6	5.9	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	31.0	-	24.9	-	19.3	-	18.1	-	14.2	ns
	propagation delay	DIR to B [1]	-	26.1	-	24.0	-	15.8	-	13.3	-	11.7	ns
PZL	OFF-state to LOW	DIR to A [1]	-	37.8	-	33.0	-	20.4	-	18.0	-	14.5	ns
	propagation delay	DIR to B [1]	-	26.4	-	23.2	-	17.3	-	15.0	-	14.1	ns
/ _{CC(A)} =	3.0 V to 3.6 V												
PLH	LOW to HIGH	A to B	2.0	18.9	1.8	17.1	1.2	8.8	0.7	6.2	0.6	4.9	ns
	propagation delay	B to A	1.5	13.0	1.5	8.0	1.1	6.9	0.6	6.2	0.5	6.0	ns
PHL	HIGH to LOW	A to B	1.9	17.2	1.8	13.9	1.1	7.7	0.7	5.5	0.6	4.4	ns
	propagation delay	B to A	1.5	12.0	1.6	7.9	1.1	6.0	0.7	5.5	0.6	5.0	ns
^t рнz	HIGH to OFF-state	DIR to A	2.0	8.1	2.0	8.1	2.0	8.1	2.0	8.1	2.4	8.1	ns
	propagation delay	DIR to B	2.6	19.8	2.6	18.2	2.0	11.2	2.4	9.5	1.9	7.0	ns
t _{PLZ}	LOW to OFF-state	DIR to A	1.8	6.2	1.8	6.2	1.8	6.2	1.8	6.2	1.8	6.2	ns
	propagation delay	DIR to B	2.0	15.0	2.1	13.8	1.7	8.6	2.0	7.9	1.5	5.4	ns
^t PZH	OFF-state to HIGH	DIR to A [1]	-	28.0	-	21.8	-	15.5	-	14.1	-	11.4	ns
	propagation delay	DIR to B [1]	-	25.1	-	23.3	-	15.0	-	12.4	-	11.1	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	-	31.8	-	26.1	-	17.2	-	15.0	-	12.0	ns
	propagation delay	DIR to B [1]	-	25.3	-	22.0	-	15.8	-	13.6	-	12.5	ns
V _{CC(A)} =	4.5 V to 5.5 V												
PLH	LOW to HIGH	A to B	1.9	18.3	1.7	16.7	0.9	8.3	0.6	6.0	0.4	4.3	ns
	propagation delay	B to A	1.4	11.6	1.2	7.5	0.9	5.3	0.6	4.9	0.4	4.3	ns
PHL	HIGH to LOW	A to B	2.0	16.9	1.6	13.5	0.9	6.9	0.6	5.0	0.4	3.9	ns
	propagation delay	B to A	1.5	11.9	1.5	7.7	0.8	5.1	0.6	4.4	0.4	3.9	ns
PHZ	HIGH to OFF-state	DIR to A	1.5	6.0	1.5	6.0	1.5	6.0	1.5	6.0	1.5	6.0	ns
	propagation delay	DIR to B	2.6	19.1	2.6	17.8	2.0	10.7	2.4	8.8	2.2	6.3	ns
PLZ	LOW to OFF-state	DIR to A	1.2	4.1	1.2	4.1	1.1	4.1	0.9	4.1	0.8	4.1	ns
	propagation delay	DIR to B	2.0	14.5	2.1	13.4	1.7	8.2	2.0	7.7	1.6	5.0	ns

 Table 13. Dynamic characteristics for temperature range -40 °C to +125 °C ...continued

 Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8; for wave forms see Figure 6 and Figure

74LVC_LVCH1T45_1

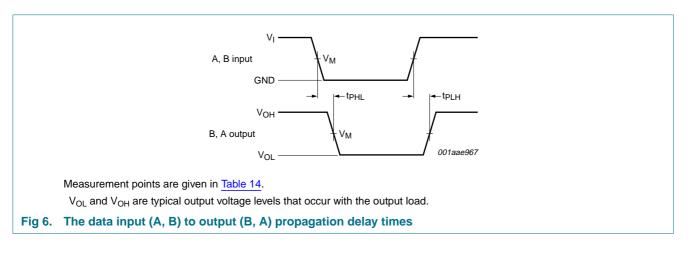
Dual supply translating transceiver; 3-state

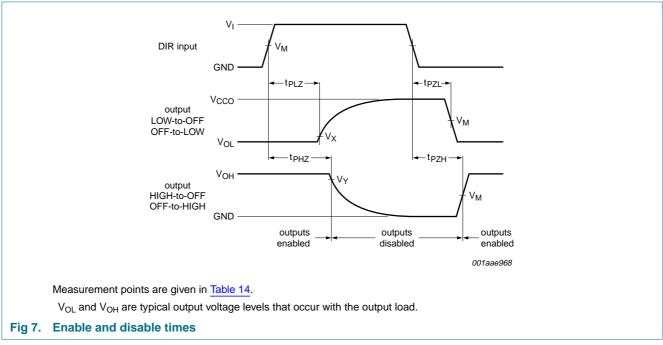
Symbol	Parameter	Condition	s					Vcc	(B)					Unit	
				1.5 V ±	: 0.1 V	1.8 V \pm	0.15 V	2.5 V ±	E 0.2 V	3.3 V ±	± 0.3 V	5.0 V ±	± 0.5 V		
				Min	Max	Min	Мах	Min	Max	Min	Max	Min	Max		
t _{PZH}	OFF-state to HIGH propagation delay	ZH OFF-state to HIGH	DIR to A	<u>[1]</u>	-	26.1	-	20.9	-	13.5	-	12.6	-	9.3	ns
		DIR to B	[1]	-	22.4	-	20.8	-	12.4	-	10.1	-	8.4	ns	
t _{PZL}		DIR to A	[1]	-	31.0	-	25.5	-	15.8	-	13.2	-	10.2	ns	
propagation delay		DIR to B	[1]	-	22.9	-	19.5	-	12.9	-	11.0	-	9.9	ns	

blo 13 10 °C to ±125 °C

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times"

12. Waveforms





74LVC1T45; 74LVCH1T45

Dual supply translating transceiver; 3-state

Table 14.Measurement points

Supply voltage	Input ^[1]	Output ^[2]		
V _{CC(A)} , V _{CC(B)}	V _M	V _M	V _X	V _Y
1.2 V to 1.6 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.1 V	V _{OH} – 0.1 V
1.65 V to 2.7 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.15 V	V _{OH} – 0.15 V
3.0 V to 5.5 V	0.5V _{CCI}	$0.5V_{CCO}$	V _{OL} + 0.3 V	V _{OH} – 0.3 V

 $\label{eq:VCCI} \mbox{is the supply voltage associated with the data input port.}$

[2] V_{CCO} is the supply voltage associated with the output port.

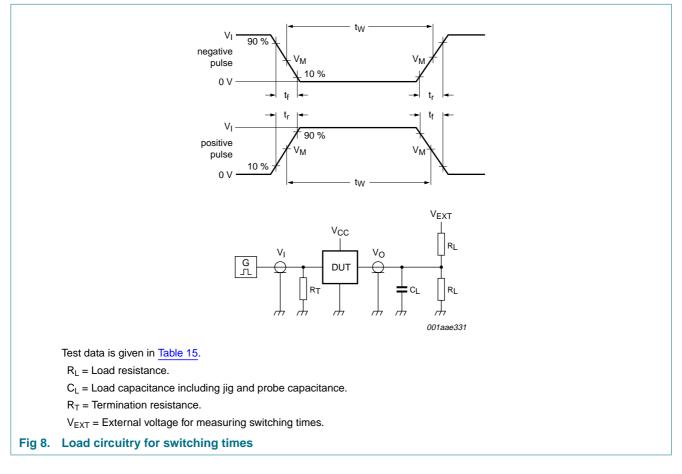


Table 15.Test data

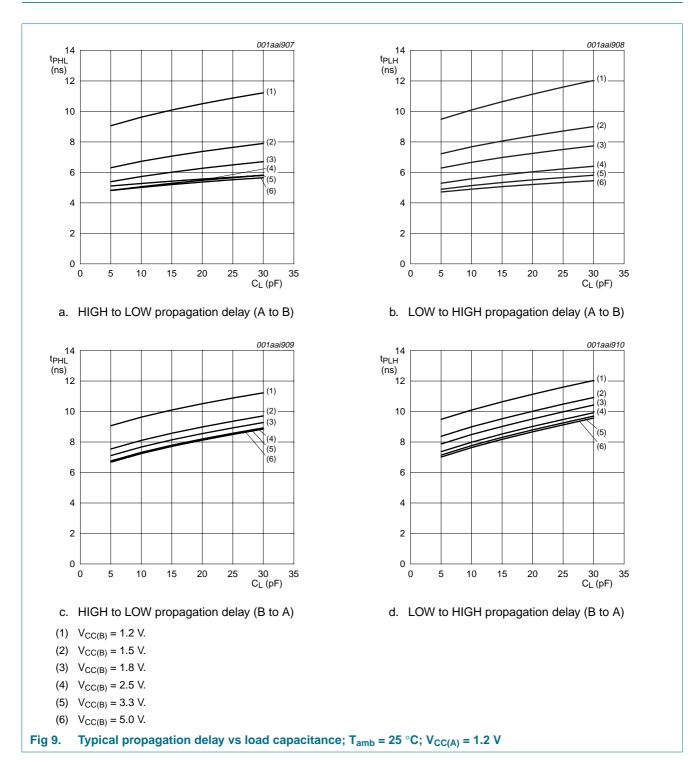
Supply voltage	Input		Load		V _{EXT}		
V _{CC(A)} , V _{CC(B)}	V [1]	∆t/∆V[2]	CL	RL	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ} [3]
1.2 V to 5.5 V	V _{CCI}	\leq 1.0 ns/V	15 pF	2 kΩ	open	GND	2V _{CCO}

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] dV/dt ≥ 1.0 V/ns

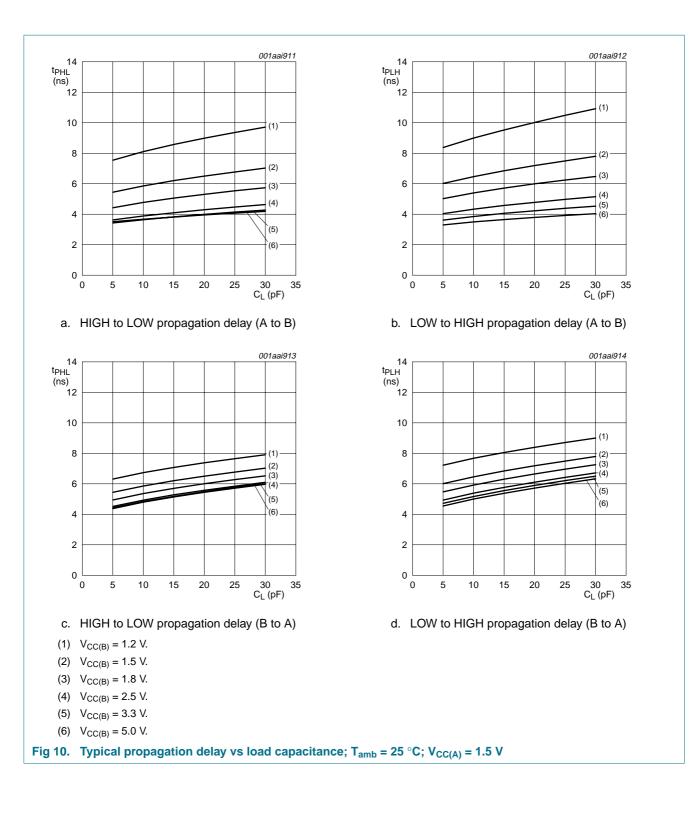
[3] V_{CCO} is the supply voltage associated with the output port.

Dual supply translating transceiver; 3-state

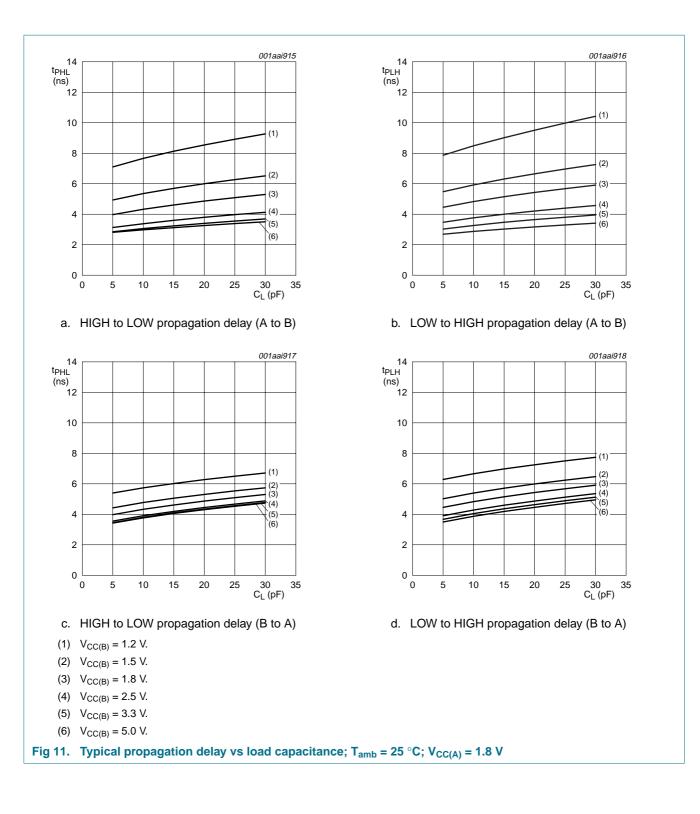


13. Typical propagation delay characteristics

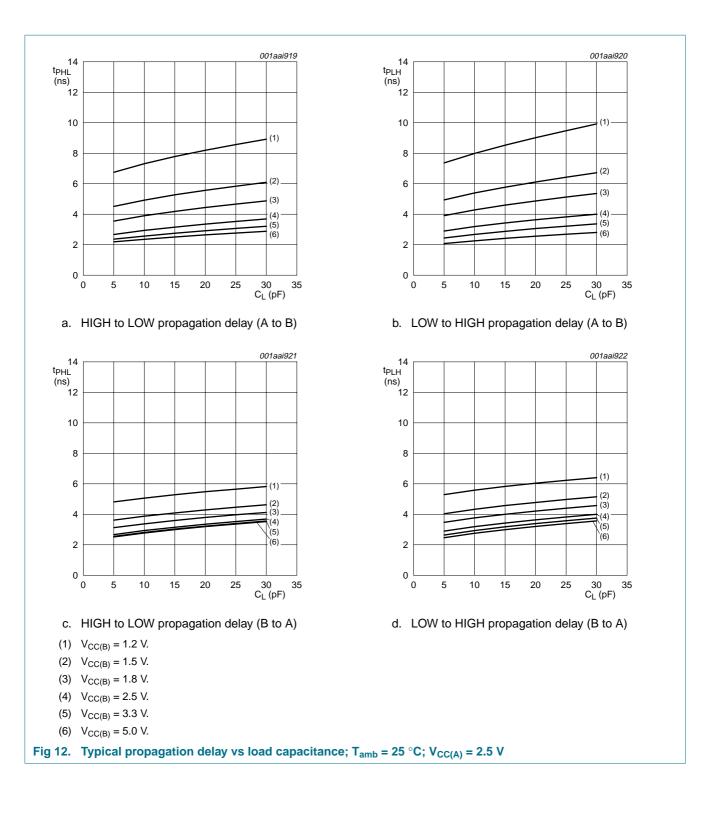
74LVC1T45; 74LVCH1T45



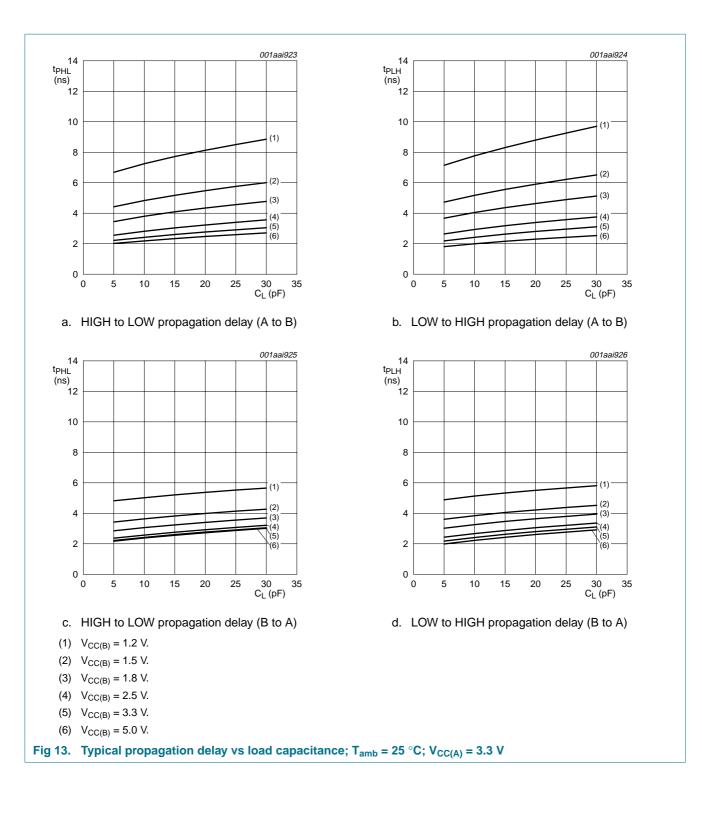
74LVC1T45; 74LVCH1T45



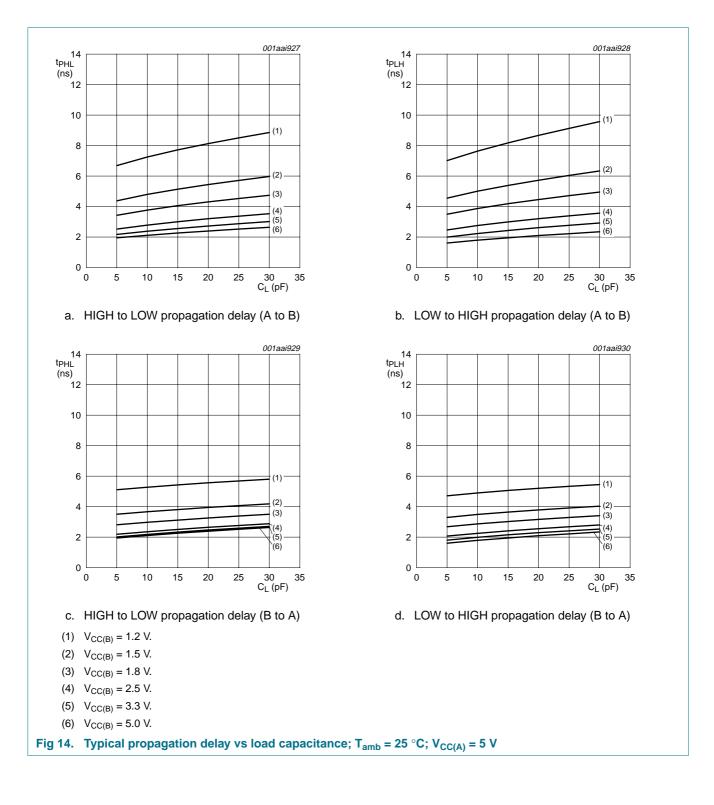
74LVC1T45; 74LVCH1T45



74LVC1T45; 74LVCH1T45



74LVC1T45; 74LVCH1T45



Dual supply translating transceiver; 3-state

14. Application information

14.1 Unidirectional logic level-shifting application

The circuit given in <u>Figure 15</u> is an example of the 74LVC1T45; 74LVCH1T45 being used in an unidirectional logic level-shifting application.

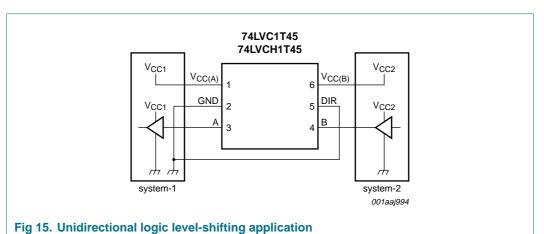
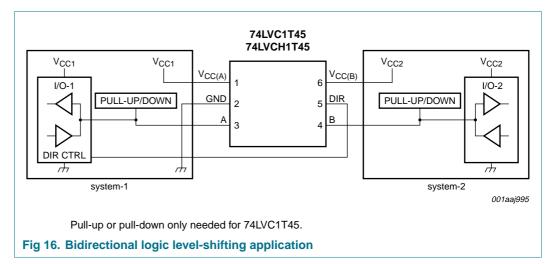


Table '	16. Descrip	otion unidirectio	nal logic level-shifting application
Pin	Name	Function	Description
1	V _{CC(A)}	V _{CC1}	supply voltage of system-1 (1.2 V to 5.5 V)
2	GND	GND	device GND
3	А	OUT	output level depends on V _{CC1} voltage
4	В	IN	input threshold value depends on V_{CC2} voltage
5	DIR	DIR	the GND (LOW level) determines B port to A port direction
6	V _{CC(B)}	V _{CC2}	supply voltage of system-2 (1.2 V to 5.5 V)

Dual supply translating transceiver; 3-state

14.2 Bidirectional logic level-shifting application

Figure 16 shows the 74LVC1T45; 74LVCH1T45 being used in a bidirectional logic level-shifting application. Since the device does not have an output enable pin, the system designer should take precautions to avoid bus contention between system-1 and system-2 when changing directions.



<u>Table 17</u> gives a sequence that will illustrate data transmission from system-1 to system-2 and then from system-2 to system-1.

State	DIR CTRL	I/O-1	I/O-2	Description
1	Н	output	input	system-1 data to system-2
2	Н	Z	Z	system-2 is getting ready to send data to system-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on bus hold.
3	L	Z	Z	DIR bit is set LOW. I/O-1 and I/O-2 still are disabled. The bus-line state depends on bus hold.
4	L	input	output	system-2 data to system-1

Table 17. Description bidirectional logic level-shifting application^[1]

[1] H = HIGH voltage level;

L = LOW voltage level;

Z = high-impedance OFF-state.

Dual supply translating transceiver; 3-state

14.3 Power-up considerations

The device is designed such that no special power-up sequence is required other than GND being applied first.

V _{CC(A)}	V _{CC(B)}	Unit				
	0 V	1.8 V	2.5 V	3.3 V	5.0 V	
0 V	0	< 1	< 1	< 1	< 1	μA
1.8 V	< 1	< 2	< 2	< 2	2	μA
2.5 V	< 1	< 2	< 2	< 2	< 2	μA
3.3 V	< 1	< 2	< 2	< 2	< 2	μA
5.0 V	< 1	2	< 2	< 2	< 2	μA

Table 18. Typical total supply current (I_{CC(A)} + I_{CC(B)})

14.4 Enable times

Calculate the enable times for the 74LVC1T45; 74LVCH1T45 using the following formulas:

- t_{PZH} (DIR to A) = t_{PLZ} (DIR to B) + t_{PLH} (B to A)
- t_{PZL} (DIR to A) = t_{PHZ} (DIR to B) + t_{PHL} (B to A)
- t_{PZH} (DIR to B) = t_{PLZ} (DIR to A) + t_{PLH} (A to B)
- t_{PZL} (DIR to B) = t_{PHZ} (DIR to A) + t_{PHL} (A to B)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the 74LVC1T45; 74LVCH1T45 initially is transmitting from A to B, then the DIR bit is switched, the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

Dual supply translating transceiver; 3-state

15. Package outline

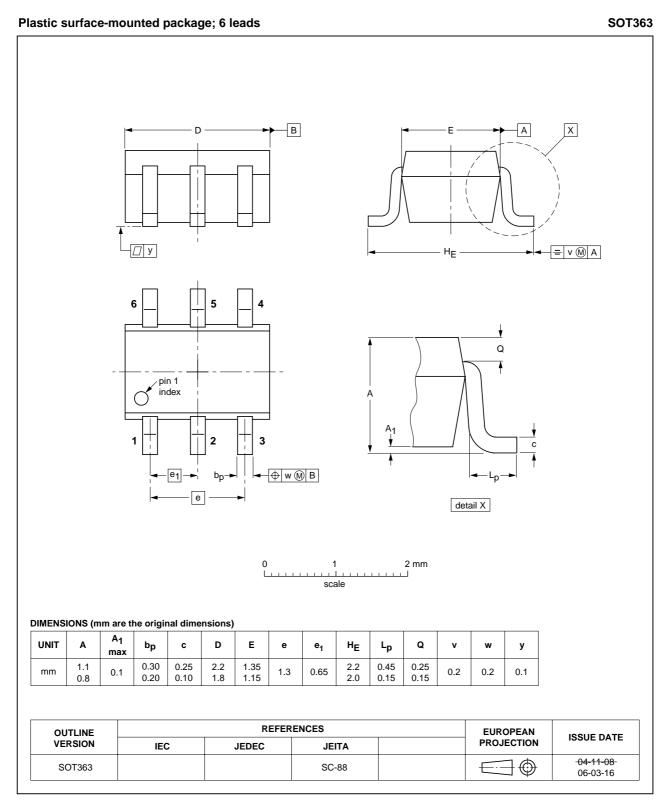


Fig 17. Package outline SOT363 (SC-88)

Dual supply translating transceiver; 3-state

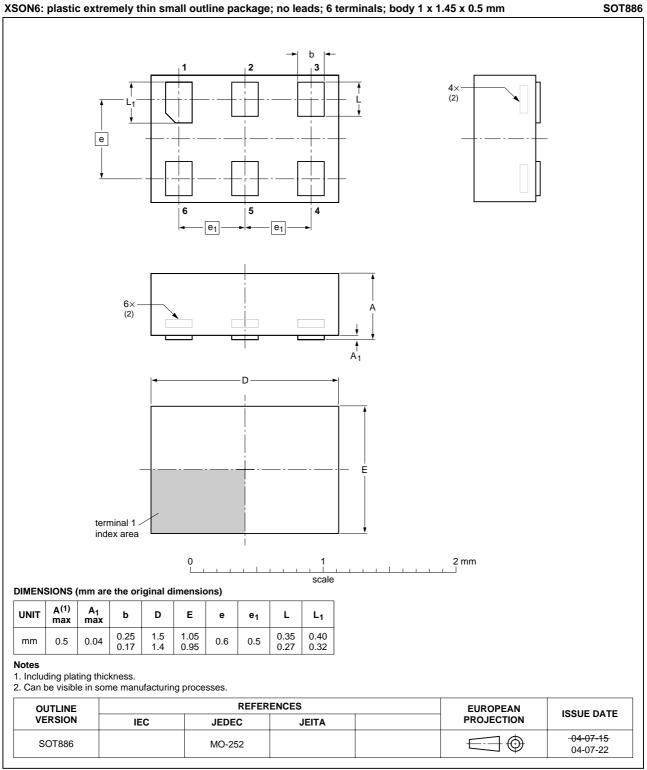


Fig 18. Package outline SOT886 (XSON6)

74LVC_LVCH1T45_1
Product data sheet

Dual supply translating transceiver; 3-state

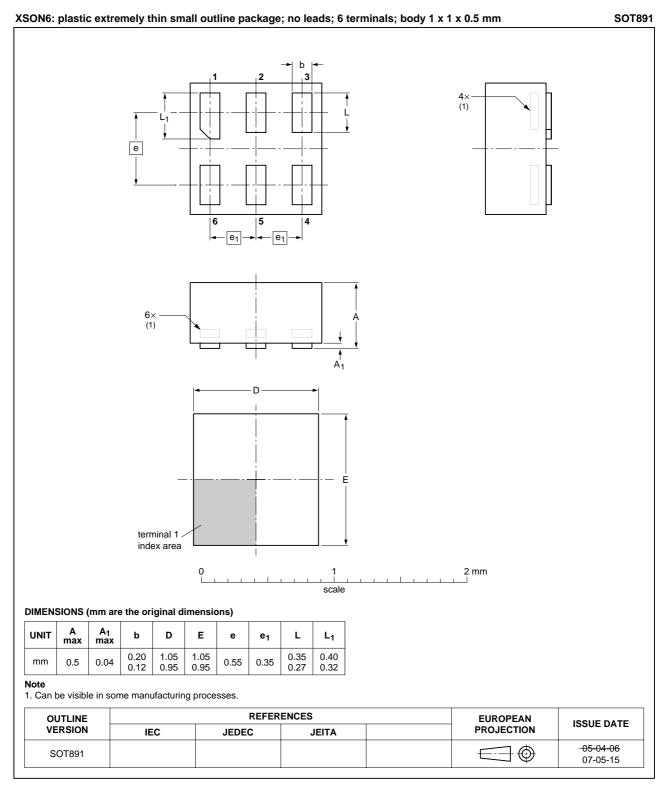


Fig 19. Package outline SOT891 (XSON6)

74LVC_LVCH1T45_1
Product data sheet



Dual supply translating transceiver; 3-state

16. Abbreviations

Table 19. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
CMOS	Complementary Metal Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			

17. Revision history

Table 20. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC_LVCH1T45_1	20090511	Product data sheet	-	-	

Dual supply translating transceiver; 3-state

18. Legal information

18.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

18.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

18.3 Disclaimers

General — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

18.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

19. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

74LVC1T45; 74LVCH1T45

Dual supply translating transceiver; 3-state

20. Contents

1	General description 1
2	Features 1
3	Ordering information 2
4	Marking 2
5	Functional diagram 3
6	Pinning information 3
6.1	Pinning 3
6.2	Pin description 3
7	Functional description 4
8	Limiting values 4
9	Recommended operating conditions 4
10	Static characteristics 5
11	Dynamic characteristics 9
12	Waveforms 14
13	Typical propagation delay characteristics 16
14	Application information 22
14.1	Unidirectional logic level-shifting application. 22
14.2	Bidirectional logic level-shifting application 23
14.3	Power-up considerations 24
14.4	Enable times 24
15	Package outline 25
16	Abbreviations
17	Revision history 28
18	Legal information 29
18.1	Data sheet status 29
18.2	Definitions
18.3	Disclaimers
18.4	Trademarks 29
19	Contact information 29
20	Contents 30

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2009.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 11 May 2009 Document identifier: 74LVC_LVCH1T45_1

